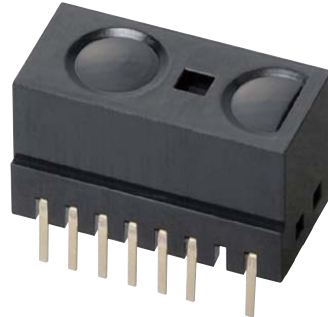


GP2Y0D810Z0F

Distance Measuring Sensor Unit
Digital output (100 mm) type



■Description

GP2Y0D810Z0F is distance measuring sensor unit, composed of an integrated combination of PD (photo diode), IRED (infrared emitting diode) and signal processing circuit.

The variety of the reflectivity of the object, the environmental temperature and the operating duration are not influenced easily to the distance detection because of adopting the triangulation method.

The output voltage of this sensor stays high in case an object exists in the specified distance range. So this sensor can also be used as proximity sensor.

■Features

1. Digital output type
2. Short distance type
Detecting distance : Typ. 100 mm
3. Low profile
Package size : 13.6×7×7.95 mm
4. Consumption current : Typ. 5 mA
5. Battery drive possible
Supply voltage : 2.7 to 6.2 V
6. Sunlight tolerance
7. Add Vin terminal, and an external transistor of Vcc line is unnecessary at intermittent operating.

■Agency approvals/Compliance

1. Compliant with RoHS directive (2002/95/EC)

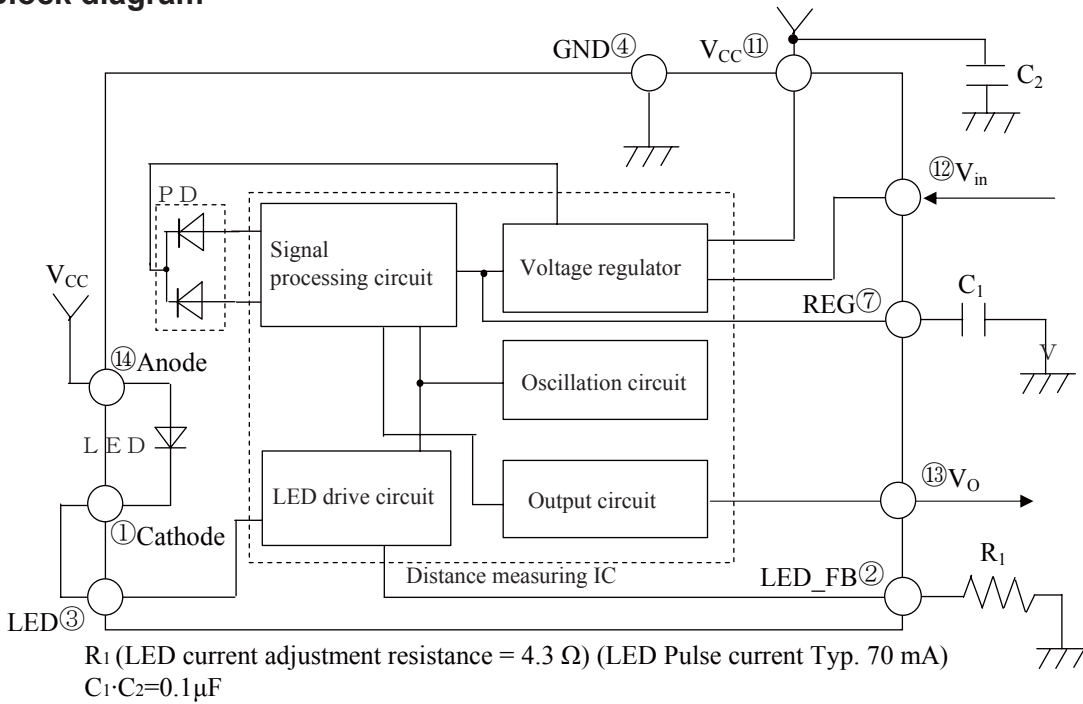
■Applications

1. Touch-less switch
(Sanitary equipment, Control of illumination, etc.)
2. Robot cleaner

Notice The content of data sheet is subject to change without prior notice.

In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that may occur in equipment using any SHARP devices shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device.

Block diagram



Outline Dimensions

(Unit : mm)

Symbol	Function
①	Cathode
②	LED_FB
③	LED
④	GND
⑤	—
⑥	—
⑦	REG
⑧	—
⑨	—
⑩	—
⑪	V _{CC}
⑫	V _{in}
⑬	V _O
⑭	Anode

— : No contact

Material	Part	Material
A	Case	PC (Color:Black)
B	Lens	PC (Visible light cut type)
C	Device coating	PPS (Color:Black)
D	Lead pin	42ALLOY (Pd-Au plating)

year	Mark
2006	U
2007	V
2008	W
2009	X
...	...
2025	T
2026	U

(Note1) Unspecified tolerances shall be ±0.3mm.
 (Note2) () : Reference value

Product mass : approx. 0.7g

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V_{CC}	-0.3 to +7	V
Output terminal voltage	V_O	-0.3 to $V_{CC}+0.3$	V
Input terminal voltage	V_{in}	-0.3 to $V_{CC}+0.3$	V
Operating temperature	T_{opr}	-10 to +60	°C
Storage temperature	T_{stg}	-20 to +70	°C
* Soldering temperature	T_{sol}	260	°C

* 5s or less/time up 2times

t = 1.0 mm One side board mounting

■ Electro-optical Characteristics

($T_a=25^\circ\text{C}$, $V_{CC}=5\text{V}$)

Parameter	Symbol	Rating	MIN.	TYP.	MAX.	Unit
Average supply current	I_{CC1}	$V_{CC}=5\text{V}$, $V_{in}=5\text{V}$, $R_1=4.3\Omega$ (*1)	—	5	6.5	mA
Average supply current	I_{CC2}	$V_{CC}=5\text{V}$, $V_{in}=5\text{V}$, $R_1=4.3\Omega$ (*1)	—	9	10.5	mA
Stand-by supply current	I_{CC3}	$V_{CC}=5\text{V}$, $V_{in}=0\text{V}$	—	5	8	μA
Output voltage	V_{OH}	Output voltage at high level	$V_{CC}-0.6$	—	—	V
	V_{OL}	Output voltage at low level	—	—	0.6	V
Detecting distance	L	(*2)(*3)	80	100	130	mm

(*1) I_{CC1} : (LED Emitting time : Typ. $20\ \mu\text{s} \times 8$ times), I_{CC2} : (Emitting time : Typ. $20\ \mu\text{s} \times 15$ times),
LED Pulse Current : Typ. 70 mA

(*2) Using reflective object : White paper (Made by Kodak Co., Ltd. gray cards R-27·white face, reflectance ; 90%)

(*3) Output voltage switch has a hysteresis width. The distance specified by L should be
the distance which the output turns from L to H in case an object moves to the sensor.

■ Recommended operating conditions

Parameter	Symbol	Conditions	Rating	Unit
Supply voltage	V_{CC}		2.7 to 6.2	V
High level input voltage	V_{inH}	CMOS level signal. Operating	MIN $V_{CC}-0.2$	V
Low level input voltage	V_{inL}	CMOS level signal. Standby state	MAX 0.2	V

Fig. 1 Timing chart

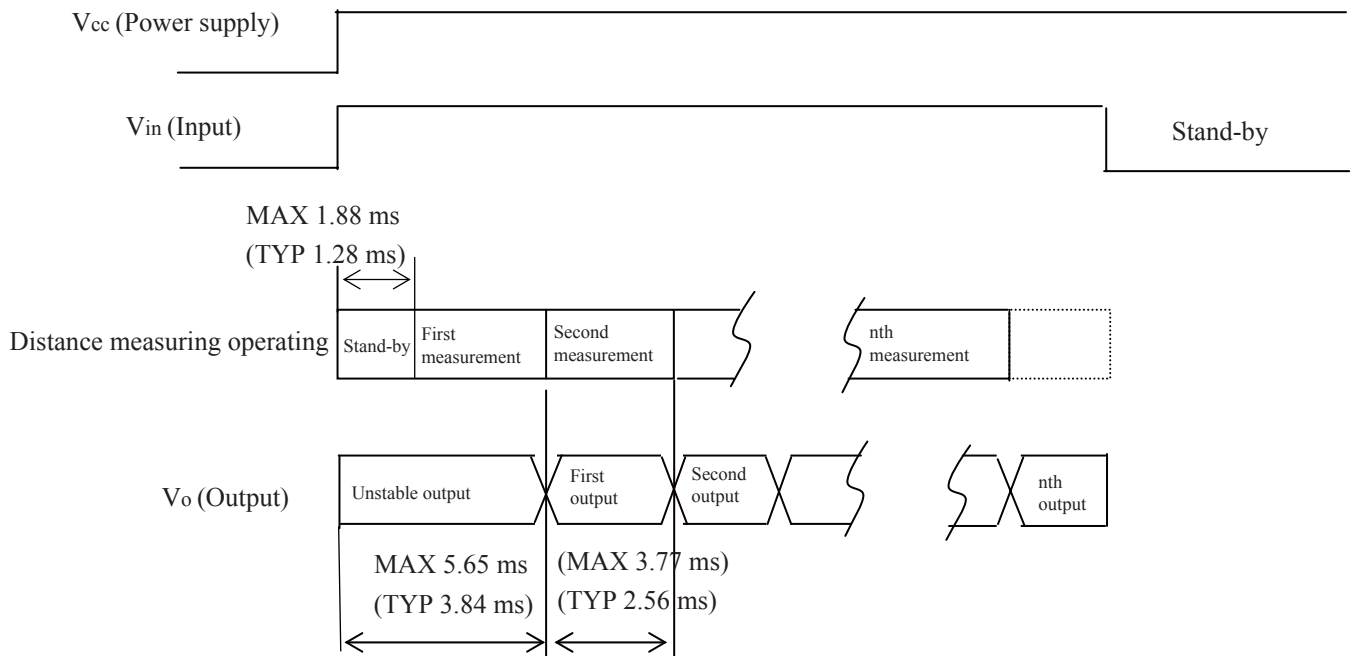
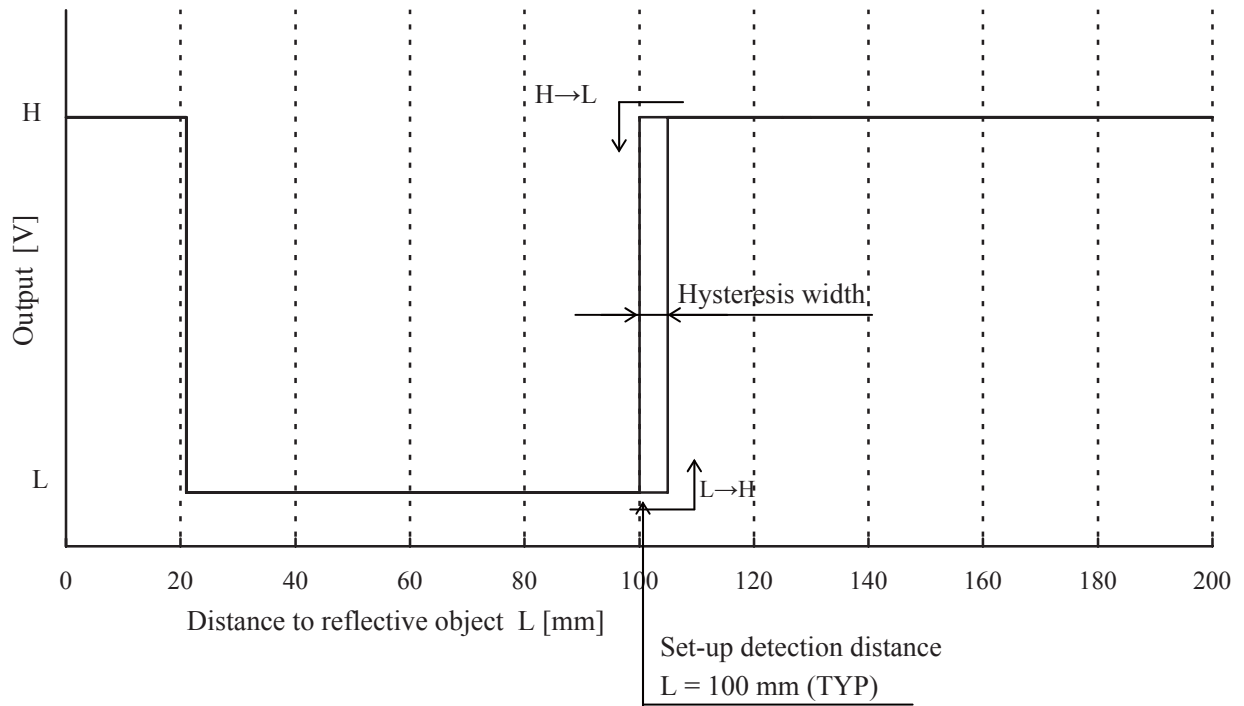


Fig. 2 Example of distance measuring characteristics (output)



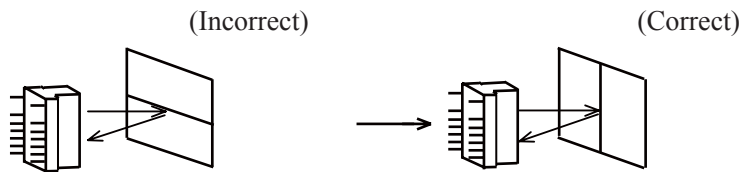
■ Notes

● Advice for the optics

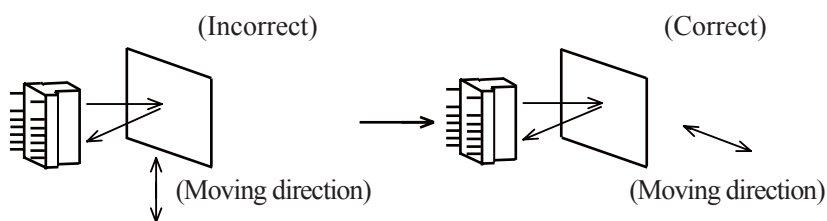
- The lens of this device needs to be kept clean. There are cases that dust, water or oil and so on deteriorate the characteristics of this device. Please consider in actual application.
- Please don't do washing. Washing may deteriorate the characteristics of optical system and so on. Please confirm resistance to chemicals under the actual usage since this product has not been designed against washing.

● Advice for the characteristics

- In case that an optical filter is set in front of the emitter and detector portion, the optical filter which has the most efficient transmittance at the emitting wavelength range of LED for this product ($\lambda = 870 \pm 70\text{nm}$), shall be recommended to use. Both faces of the filter should be mirror polishing. Also, as there are cases that the characteristics may not be satisfied according to the distance between the protection cover and this product or the thickness of the protection cover, please use this product after confirming the operation sufficiently in actual application.
- In case that there is an object near to emitter side of the sensor between sensor and a detecting object, please use this device after confirming sufficiently that the characteristics of this sensor do not change by the object.
- When the detector is exposed to the direct light from the sun, tungsten lamp and so on, there are cases that it can not measure the distance exactly. Please consider the design that the detector is not exposed to the direct light from such light source.
- Distance to a mirror reflector can not be sometimes measured exactly.
In case of changing the mounting angle of this product, it may measure the distance exactly.
- In case that reflective object has boundary line which material or color etc. are excessively different, in order to decrease deviation of measuring distance, it shall be recommended to set the sensor that the direction of boundary line and the line between emitter center and detector center are in parallel.



- In order to decrease deviation of measuring distance by moving direction of the reflective object, it shall be recommended to set the sensor that the moving direction of the object and the line between emitter center and detector center are vertical.



● Notes on handling

- There are some possibilities that the internal components in the sensor may be exposed to the excessive mechanical stress. Please be careful not to cause any excessive pressure on the sensor package and also on the PCB while assembling this product.
- Soldering shall be done with a soldering iron and below 260°C , less than 5s and maximum 2 times. Also, please pay attention not to put out force on lead terminals while soldering. Please do not apply flow soldering because it may damage optical lens of the device.

● Presence of ODC etc.

This product shall not contain the following materials.

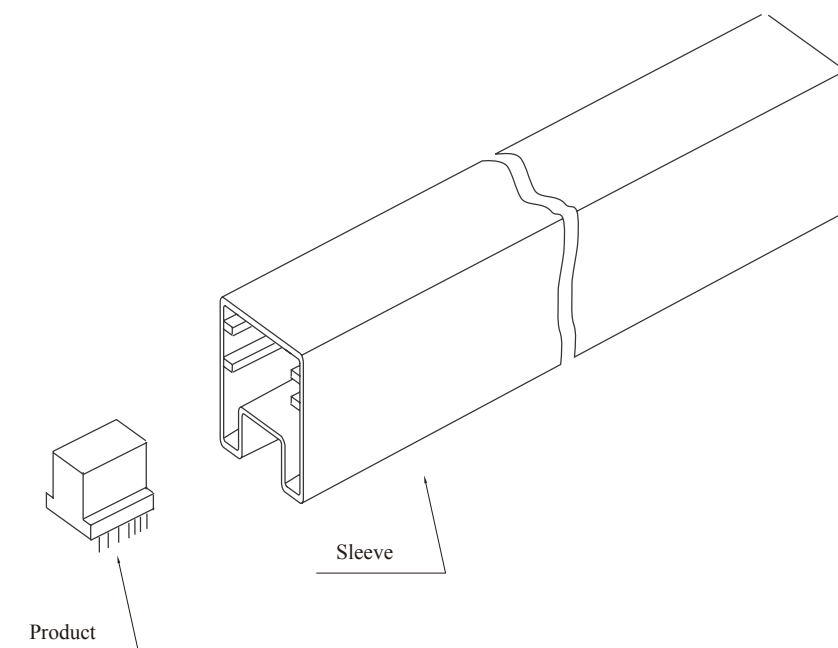
And they are not used in the production process for this product.

Regulation substances : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBB and PBDE are not used in this product at all.

This product shall not contain the following materials banned in the RoHS Directive (2002/95/EC).

- Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBB), Polybrominated diphenyl ethers (PBDE).

■ Package specification

Put products of 40 pieces in sleeve.

■ Important Notices

· The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.

· Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.

· Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:

(i) The devices in this publication are designed for use in general electronic equipment designs such as:

- Personal computers
- Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

with equipment that requires higher reliability such as:

- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).

· If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Law of Japan, it is necessary to obtain approval to export such SHARP devices.

· This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.

· Contact and consult with a SHARP representative if there are any questions about the contents of this publication.